

Features

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitance
- Easy to Parallel and Simple to Drive

Benefts

- Higher system effciency
- Reduce cooling requirements
- · Increase power density
- · Increase system switching frequency

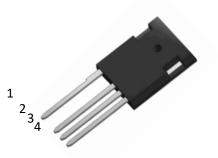
Applications

- Renewable energy
- · EV battery chargers

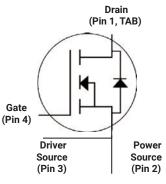
Ordering Part

Number HC3M0015120K

- High voltage DC/DC converters
- Switch Mode Power Supplies







Maximum Ratings (Tc = 25 °C unless otherwise specifed)

Package

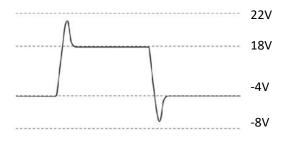
TO-247-4L

Parameter	Symbol	Value	Unit
Drain-source voltage	Vds	1200	V
Continuous drain current			
Tc = 25°C Tc = 100°C	D	117 84	A
Pulsed drain current (Tc = 25°C, t_p limited by T_{jmax})	ID pulse	250	А
Gate-Source voltage	Vgs	-4/+18	V
Gate-Source voltage (dynamic,Absolute maximum values)	VGSmax	-8/+22	V
Power dissipation (Tc = 25° C)	Ptot	556	W
Operating junction and storage temperature	Tj,Tstg	-55+175	°C

Marking

HC3M0015120K

• Example of acceptable Vgs waveform



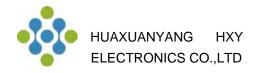


Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal resistance, junction – case. Max	RthJC	0.27	°C/W
Thermal resistance, junction – ambient. Max	RthJA	40	0/11

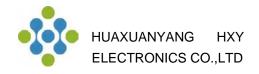
Electrical Characteristic (at Tj = 25 °C, unless otherwise specified)

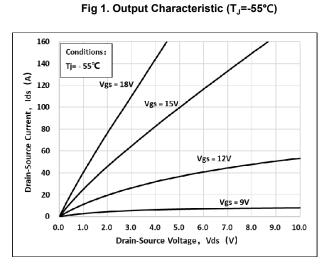
Parameter	Symbol	Value			Unit	Test Condition	
Farameter	Symbol	min.	typ.	max.	Unit	Test Condition	
Static Characteristic							
Drain-source breakdown voltage	BVDSS	1200	-	-	V	Vgs=0V, Id=250uA	
Gate threshold voltage	VGS(th)	2	-	4	V	Vds=Vgs,Id=25mA	
Zero gate voltage drain current	ldss	-	1 10	50 -	μA	V _{DS} =1200V,V _{GS} =0V T _j =25°C T _j =175°C	
Gate-source leakage current	lgss	-		200	nA	Vgs=18V,Vds=0V	
Drain-source on-state resistance	RDS(on)	-	33 50	49 -	m	V _{GS} =20V, ID=80A, Tj=25°C Tj=175°C	
Transconductance	g fs	-	27	-	S	VDS=20V,ID=40A	
Dynamic Characteristic					-		
Input Capacitance	Ciss	-	4508	-		V _{DS} = 1000V V _{GS} = 0V	
Output Capacitance	Coss	-	214	-	рF	$T_{J} = 25^{\circ}C$ $V_{AC} = 25mV$ $f = 1MHz$	
Reverse Transfer Capacitance	Crss	-	26	-			
Gate Total Charge	QG	-	222	-		VDS = 800V VGS = -0/18V ID = 80A	
Gate-Source charge	Qgs	-	46.4	-	nC		
Gate-Drain charge	Q _{gd}	-	77.6	-]		
Turn-On Switching Energy	Eon	-	2290	-		$V_{DD} = 800V$ $V_{GS} = -4/+18V$ $I_D = 80A$ $R_G = 5$ L = 120uH	
Turn-Off Switching Energy-	Eoff	-	630		μJ		
Turn-on delay time	td(on)	-	49.2	-	20		
Rise time	tr	-	14.2	-			
Turn-off delay time	td(off)	-	21.7	-	ns		
Fall time	tr	-	11.3	-			
Gate resistance	Rg	-	0.9	-		Vac = 25mV, f=1MHz	



Body Diode Characteristic

Parameter	er Symbol Value			Unit	Test Condition		
Falameter	Symbol	min.	typ.	max.	Onic	Test Condition	
Body Diode Forward Voltage	Vsd		4.4		V	Vgs=0V,Isd=40A, Tj=25°C	
Body Diode Forward Voltage	V 5D		3.9			Vgs=0V,Isd=40A, Tj=175°C	
Body Diode Reverse Recovery Time	trr	-	29.6	-	ns	Vr = 400V, ID = 80A	
Body Diode Reverse Recovery Charge	Qrr	-	272	-	nC	di/dt = 1000A/µS	





Typical Performance Characteristics



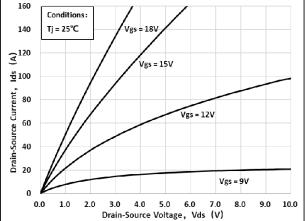
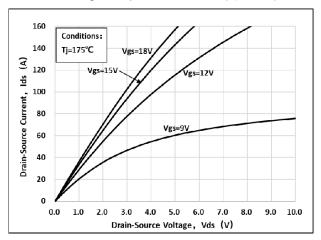
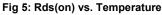


Fig 3. Output Characteristic (TJ=175℃)





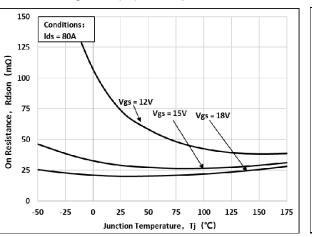


Fig 4: Rdson Vs Ids Characteristic

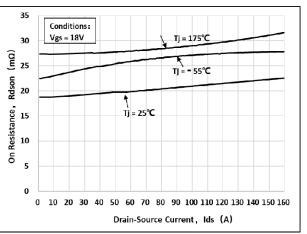
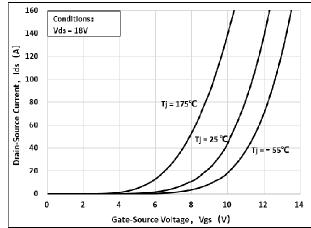
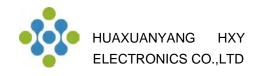


Fig 6: Transfer Characteristic





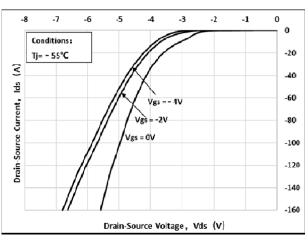


Fig 9: Body-diode Characteristic (T_J=175℃)

Fig 7: Body-diode Characteristic (T_J=-55°C)

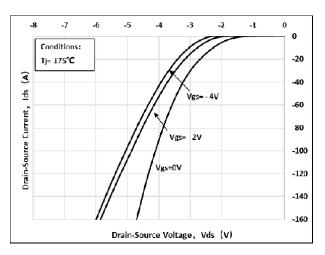
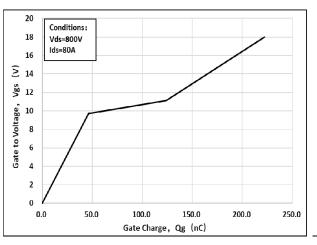


Fig 11: Gate Charge Characteristics



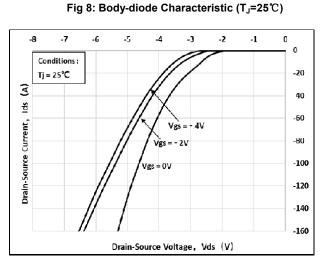
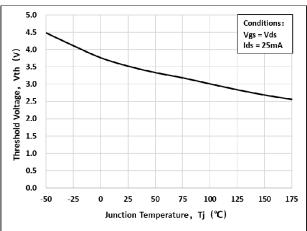
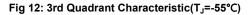
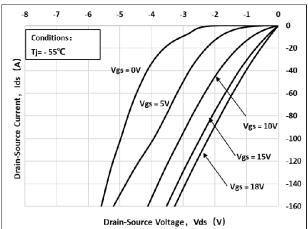
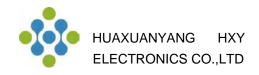


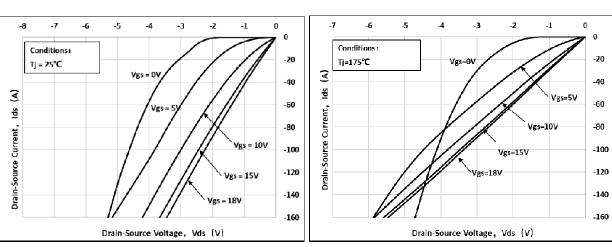
Fig 10: V_{TH} Vs T_J Temperature Characteristic







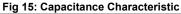


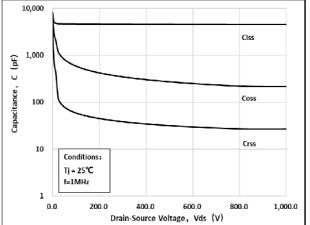


Drain-Source Current, I_{DS} (A)

Fig 13: 3rd Quadrant Characteristic(T_J=25℃)

Fig 14: 3rd Quadrant Characteristic(T_J=175℃)







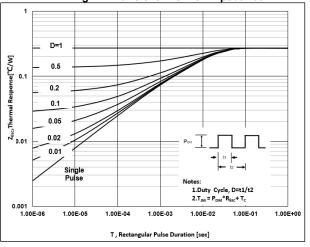


Fig 16: Safe Operating Area

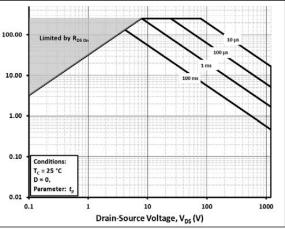




Figure B. Dynamic test circuit

Test Circuit Schematic

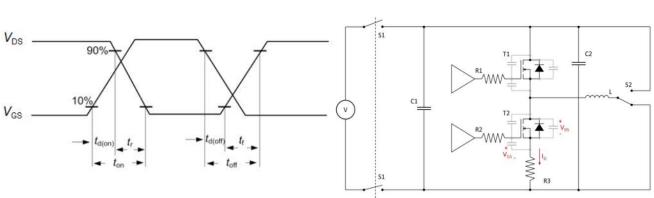


Figure A. Definition of switching times

Figure C. Definition of body diodeswitching characteristics

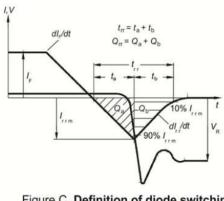
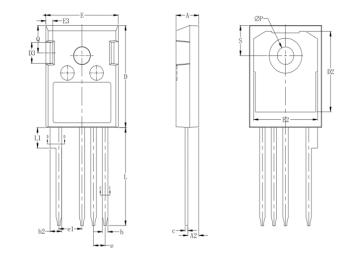


Figure C. Definition of diode switching characteristics



Package Dimensions

Package TO-247-4L



Itoma	Values(mm)				
Items	MIN	MAX			
A	4.8	5.2			
A2	2.2	2.6			
b	1.05	1.4			
b2	2.4	2.75			
с	0.5	0.75			
D	20	21.5			
D2	15.5	17.2			
D3	4	5			
E	15.5	16.1			
E2	13	15			
E3	1	2			
е	2.54 BSC.				
e1	5.08 BSC.				
L	19	21			
L1	4	4.45			
ΦΡ	3.5	3.7			
Q	5.4	5.9			
S	5.9 6.4				



Attention

Any and all HUA XUAN YANG ELECTRONICS products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your HUA XUAN YANG ELECTRONICS representative nearest you before using any HUA XUAN YANG ELECTRONICS products described or contained herein in such applications.

• HUA XUAN YANG ELECTRONICS assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all HUA XUAN YANG ELECTRONICS products described or contained herein.

• Specifications of any and all HUA XUAN YANG ELECTRONICS products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

HUA XUAN YANG ELECTRONICS CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.

In the event that any or all HUA XUAN YANG ELECTRONICS products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.

• No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of HUA XUAN YANG ELECTRONICS CO.,LTD.

Information (including circuit diagrams and circuit parameters) herein is for example only ; it is not guaranteed for volume production. HUA XUAN YANG ELECTRONICS believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.

Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the HUA XUAN YANG ELECTRONICS product that you intend to use.